

**Élan™ SC400 Microcontroller  
μforCE™ Demonstration System  
Reference Manual**

Order #21892B



# Élan™SC400 Microcontroller μforCE™ Demonstration System Reference Manual

© Copyright 1999 Advanced Micro Devices, Inc. All rights reserved.

The contents of this document are provided in connection with Advanced Micro Devices, Inc. ("AMD") products. AMD makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this publication. Except as set forth in AMD's Standard Terms and Conditions of Sale, AMD assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

AMD's products are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or in any other application in which the failure of AMD's product could create a situation where personal injury, death, or severe property or environmental damage may occur. AMD reserves the right to discontinue or make changes to its products at any time without notice.

AMD, the AMD logo, and combinations thereof are trademarks of Advanced Micro Devices, Inc. Am486 is a registered trademark, μforCE, Élan, and E86 are trademarks, and FusionE86 is a service mark of Advanced Micro Devices, Inc.

Microsoft is a registered trademark of Microsoft Corp.

Windows is a registered trademark of Microsoft Corp.

Other product or brand names are used solely for identification and may be the trademarks or registered trademarks of their respective companies.

## IF YOU HAVE QUESTIONS, WE'RE HERE TO HELP YOU.

The AMD customer service network includes U.S. offices, international offices, and a customer training center. Expert technical assistance is available from the AMD worldwide staff of field application engineers and factory support staff to answer E86™ family hardware and software development questions.

Frequently accessed numbers are listed below. Additional contact information is listed on the back of this manual. AMD's WWW site lists the latest phone numbers.

### Technical Support

Answers to technical questions are available online, through e-mail, and by telephone.

Go to AMD's home page at [www.amd.com](http://www.amd.com) and follow the Service link for the latest AMD technical support phone numbers, software, and Frequently Asked Questions.

For technical support questions on all E86 products, send e-mail to [epd.support@amd.com](mailto:epd.support@amd.com) (in the US and Canada) or [euro.tech@amd.com](mailto:euro.tech@amd.com) (in Europe and the UK).

You can also call the AMD Corporate Applications Hotline at:

(800) 222-9323	Toll-free for U.S. and Canada
44-(0) 1276-803-299	U.K. and Europe hotline

### WWW Support

For specific information on E86 products, access the AMD home page at [www.amd.com](http://www.amd.com) and follow the Embedded Processors link. These pages provide information on upcoming product releases, overviews of existing products, information on product support and tools, and a list of technical documentation. Support tools include online benchmarking tools and CodeKit software—tested source code example applications. Many of the technical documents are available online in PDF form.

Questions, requests, and input concerning AMD's WWW pages can be sent via e-mail to [webmaster@amd.com](mailto:webmaster@amd.com).

### Documentation and Literature Support

Data books, user's manuals, data sheets, application notes, and product CDs are free with a simple phone call. Internationally, contact your local AMD sales office for product literature.

To order literature, call:

(800) 222-9323	Toll-free for U.S. and Canada
(512) 602-5651	Direct dial worldwide
(512) 602-7639	Fax

### Third-Party Support

AMD FusionE86<sup>SM</sup> partners provide an array of products designed to meet critical time-to-market needs. Products and solutions available include emulators, hardware and software debuggers, board-level products, and software development tools, among others. The WWW site and the *E86™ Family Products Development Tools CD*, order #21058, describe these solutions. In addition, mature development tools and applications for the x86 platform are widely available in the general marketplace.

## **THIRD-PARTY DEVELOPMENT SUPPORT TOOLS**

### **ALPs Electric, Inc.**

Nick Shimada - Sales (919) 755-3750

### **bsquare Tools**

- ÉlanSC400 microcontroller OEM adaptation kit (OAK): includes drivers and HAL (Hardware Abstraction Layer) specific to the ÉlanSC400 CPU and system logic
- Windows CE design and training experience

For more information, e-mail [sales@bsquare.com](mailto:sales@bsquare.com) or go to bsquare's web site at [www.bsquare.com/consulting](http://www.bsquare.com/consulting).

### **Crystal Semiconductor Corporation**

Crystal Semiconductor Corp., P.O. Box 17847, 4210 S. Industrial Dr., Austin, TX 78760.  
Tel: (512) 445-7222, Fax: (512) 445-7581.

### **Micrel Semiconductor**

Brian Huffman, Product Marketing Manager - Power Products, 1849 Fortune Dr., San Jose, CA 95131. Tel: (408) 944-0800 x3336.

### **Microsoft®**

- Windows® CE OEM Adaptation Kit (OAK) for sale by Microsoft or direct distributors
- Visual C++ Development System: cross compilers, assemblers, remote debuggers, and simulation tools: available through Microsoft or direct distributors
- Software Developer Kit (SDK) available on the Microsoft web site:  
[www.microsoft.windowsce/hpc/developer](http://www.microsoft.windowsce/hpc/developer)
- Device driver kit available on the Microsoft web site:  
[www.microsoft.windowsce/hpc/developer](http://www.microsoft.windowsce/hpc/developer)

For more information, go to Microsoft's web site at [www.microsoft.com/windowsce/developer/oem/default.htm](http://www.microsoft.com/windowsce/developer/oem/default.htm).



---

# Contents

---

## About the $\mu$ forCE™ Demonstration System

Features.....	xi
Documentation .....	xii
About This Manual .....	xii
Suggested Reference Material.....	xiii
Documentation Conventions.....	xiii

## Chapter 1

---

### System Features and Components

$\mu$ forCE™ System Features.....	1-1
$\mu$ forCE™ System Components .....	1-2
Liquid Crystal Display (LCD) .....	1-2
Matrix Keyboard .....	1-3
Power Supply .....	1-3
$\mu$ forCE™ System Board .....	1-4

## Chapter 2

---

### Board Functional Description

Élan™SC400 Microcontroller .....	2-3
DRAM .....	2-4
Display .....	2-4
LCD .....	2-5
Touch Screen .....	2-6
Matrix Keyboard.....	2-6
ROM/Flash Memory.....	2-7
PC Card.....	2-7
Serial Port .....	2-7
IrDA Port .....	2-7
Audio .....	2-8
Power Supply.....	2-8

## Chapter 3

---

### Élan™SC400 Microcontroller Signals

Signal Considerations .....	3-2
Signal Descriptions.....	3-5
GPIO_CS0/SUSPDIS#.....	3-5
GPIO_CS1/DIG_CS#.....	3-5
GPIO_CS2/PEN_OFF.....	3-7
GPIO_CS4/FSTCHRG#.....	3-7
GPIO_CS5/CHARGE# .....	3-9
PIRQ0.....	3-9
PIRQ1 .....	3-9
PDRQ0 and $\overline{\text{PDACK0}}$ /PDACK# .....	3-10
$\overline{\text{LBL2}}$ /LBL2#.....	3-10

## Chapter 4

---

### Power Management

PMU Modes.....	4-3
High-Speed Mode.....	4-4
Low-Speed Mode .....	4-5
Temporary Low-Speed Mode.....	4-6
Standby Mode.....	4-7
Suspend Mode .....	4-7
Critical Suspend Mode .....	4-8

---

### Index

Index .....	Index-1
-------------	---------

---

## List of Figures

Figure 0-1. $\mu$ forCE™ Demonstration System Block Diagram .....	x
Figure 2-1. $\mu$ forCE™ System Board Layout .....	2-2
Figure 4-1. Power Management Modes .....	4-2

---

## List of Tables

Table 0-1. Notational Conventions .....	xiii
Table 1-1. LCD Specifications.....	1-2
Table 2-1. DRAM Options.....	2-4
Table 2-2. LCD Signals .....	2-5
Table 3-1. Élan™SC400 Microcontroller Signal Considerations.....	3-2
Table 3-2. GPIO_CS0 Register.....	3-5
Table 3-3. GPIO_CS1 Register.....	3-6
Table 3-4. GPIO_CS2 Register.....	3-7
Table 3-5. GPIO_CS4 Register.....	3-8
Table 3-6. GPIO_CS5 Register.....	3-9
Table 4-1. PMU Mode Description.....	4-3





---

# About the $\mu$ forCE™ Demonstration System

The  $\mu$ forCE™ demonstration system provides a reference/demonstration platform for mobile and embedded product development using the Élan™SC400 microcontroller. High performance, small size, low cost, and low power consumption are the key features of the  $\mu$ forCE demonstration system. Figure 0-1 on page x shows a block diagram of the  $\mu$ forCE system.

The  $\mu$ forCE system enables you to understand the functionality of an ÉlanSC400 microcontroller/Windows® CE-based application.

**NOTE:** The  $\mu$ forCE system is for reference and demonstration purposes only. Extended development of Élan™SC400 microcontroller/Windows CE operating system designs requires additional tools available from AMD, Microsoft®, and bsquare. For information on how to order these tools, see “Third-Party Development Support Tools” on page iv.

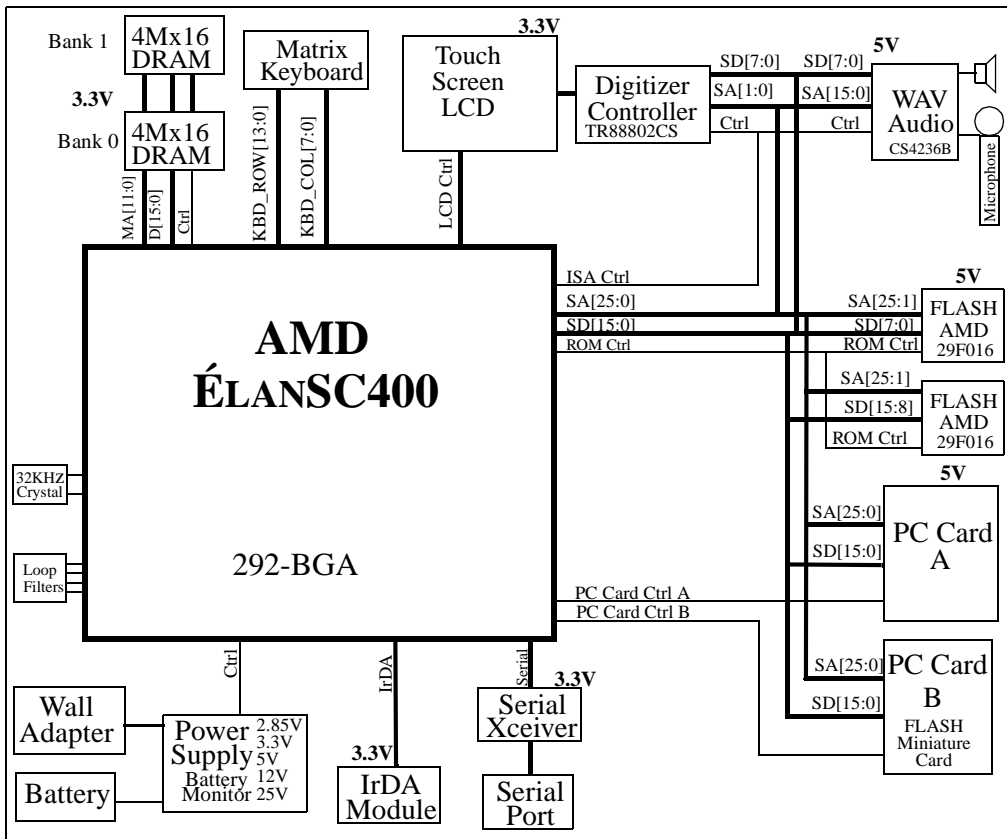


Figure 0-1.  $\mu$ forCE™ Demonstration System Block Diagram

---

# Features

The  $\mu$ forCE system provides the following features:

- Small, form-factor LCD
- Matrix keyboard
- AC/DC wall-adaptor power supply
- NiMH battery-pack power supply
- Small, form-factor demonstration board with:
  - ÉlanSC400 microcontroller
  - 8M x 16 DRAM
  - 2M x 16 Flash memory
  - Matrix keyboard interface
  - LCD interface
  - Resistive-digitizer overlay
  - WAV audio
  - PC card socket
  - Miniature Flash memory socket
  - IrDA infrared module
  - Serial port for debug

---

# Documentation

The *Élan™SC400 Microcontroller μforCE™ Demonstration System Reference Manual* provides information on the system and board features and functionality, system-specific considerations, and a description of power-management modes. Additional information can be found in “Suggested Reference Material” on page xiii.

---

## About This Manual

Chapter 1, “System Features and Components” provides a high-level description of the μforCE system.

Chapter 2, “Board Functional Description” provides descriptions of the μforCE system board features including: microcontroller, DRAM, display, keyboard, ROM/Flash memory, PC card, serial port, IrDA, audio chip, and power supply.

Chapter 3, “Élan™SC400 Microcontroller Signals” provides information about system-specific considerations for the ÉlanSC400 microcontroller used in the μforCE system.

Chapter 4, “Power Management” describes the Power Management Unit (PMU) that is used to control chip and system power.

A standard index is also included.

---

## Suggested Reference Material

- *Élan™SC400 and ÉlanSC410 Microcontrollers Data Sheet*  
Included in your kit
- *Élan™SC400 Microcontroller Register Set Reference Manual*  
Included in your kit
- *Élan™SC400 and ÉlanSC410 Microcontrollers User's Manual*  
Included in your kit
- *Am486® Microprocessor Software User's Manual*  
Advanced Micro Devices, order #18497
- *E86™ Family Products Development Tools CD*  
Advanced Micro Devices, order #20158

For current application notes and technical bulletins, see our WWW page at [www.amd.com](http://www.amd.com).

---

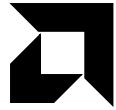
## Documentation Conventions

**Table 0-1. Notational Conventions**

Symbol	Usage
<b>Boldface</b>	Indicates that characters must be entered exactly as shown, except that the alphabetic case is only significant when indicated.
Typewriter face	Indicates computer text input or output in an example or listing.



# Chapter 1



---

## System Features and Components

To begin using the  $\mu$ forCE system, all you need to do is plug it in. If you do not see anything on the screen, try adjusting the contrast knob.

This chapter provides information about the  $\mu$ forCE system's features and components.

---

### $\mu$ forCE™ System Features

Key features of the demonstration system include small size, low cost, and low power consumption, which, combined with the ÉlanSC400 microcontroller, result in a high-performance system.

The ÉlanSC400 microcontroller used in the  $\mu$ forCE system contains a 66-MHz, Am486® microprocessor with the PC/AT system logic in a 292-pin Ball Grid Array (BGA) package. For more information about the ÉlanSC400 microcontroller, see the ÉlanSC400 documentation included in your kit.

Small size and low cost are possible because of the ÉlanSC400 microcontroller's high level of integration; very few devices are needed on the system board to complete the system. Low power consumption results from the ÉlanSC400 microcontroller's extensive power-management capabilities.

---

# μforCE™ System Components

The μforCE system consists of five main components:

- Small, form-factor Liquid Crystal Display (LCD)
- Matrix keyboard
- AC/DC wall-adaptor power supply
- NiMH battery-pack power supply
- System board (see Chapter 2, “Board Functional Description” for more information on the board)

---

## Liquid Crystal Display (LCD)

The LCD on the μforCE system is a 5.4", diagonal, 480 x 320 resolution, single-scan ALPs display panel using black-and-white super-twisted neumatic (STN) technology. This LCD has a pixel- resolution resistive-digitizer overlay that allows pen input to the system. Note that because of power considerations, the LCD is reflective; no backlight is provided.

The LCD specifications are listed in Table 1-1.

**Table 1-1. LCD Specifications**

<b>Model number</b>	<b>KHABBA904-A</b>
Display format	480 x 320
Dot pitch	0.24 x 0.24
Dot size	0.22 x 0.22
Outline dimension	135.2 x 94.8 x 6.3 mm (5.3" x 3.7" x 0.25")
Viewing area	120.2 x 81.8 mm (4.7" x 3.2")



---

## Matrix Keyboard

The  $\mu$ forCE system uses a Fujitsu matrix keyboard (model #N860-1406-T001). The keyboard connects directly to the ÉlanSC400 microcontroller's matrix keyboard interface. Software uses 7 column signals and 14 row signals to scan the keyboard for a key press.

---

## Power Supply

There are two options for applying power to the  $\mu$ forCE system: the AC/DC wall adapter or the battery pack.

### AC/DC Wall Adapter

The AC/DC wall-adapter power supply converts AC power to DC power using a universal power supply. The AC/DC wall-adapter power supply accepts 100–250 V AC and converts it to 12 V DC, 1.2 A maximum for the system's power supplies. The AC/DC wall-adapter power supply provides enough power to operate the system at top speed with no power management and with a PCMCIA card in the system. This power supply also fast charges the battery pack while the system is in Suspend mode.

### Battery Pack

The  $\mu$ forCE system can also run from batteries. The system includes a battery pack consisting of four AA, nickel metal hydride (NiMH) batteries. The battery pack provides a nominal 4.8-V, 1250-mAh power source. The batteries are charged by the system when power from the wall plug is available.

---

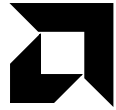
## **μforCE™ System Board**

The μforCE system includes a small, form-factor board (3" x 5.75") containing the system logic. The system board provides the following features:

- ÉlanSC400 microcontroller
- 8M x 16 DRAM
- 2M x 16 Flash memory to contain the operating system and applications
- Matrix keyboard interface
- LCD interface
- Resistive-digitizer overlay
- WAV audio
- One PC card socket
- One Flash Miniature Card socket
- IrDA infrared module
- Serial port for debug
- Power supply that operates from a wall adapter or batteries

For a detailed description of the μforCE system board components, see Chapter 2, “Board Functional Description”.

# Chapter 2



---

## Board Functional Description

This chapter provides information about the  $\mu$ forCE system board features and components. Figure 2-1 on page 2-2 shows the layout of the  $\mu$ forCE demonstration system board.

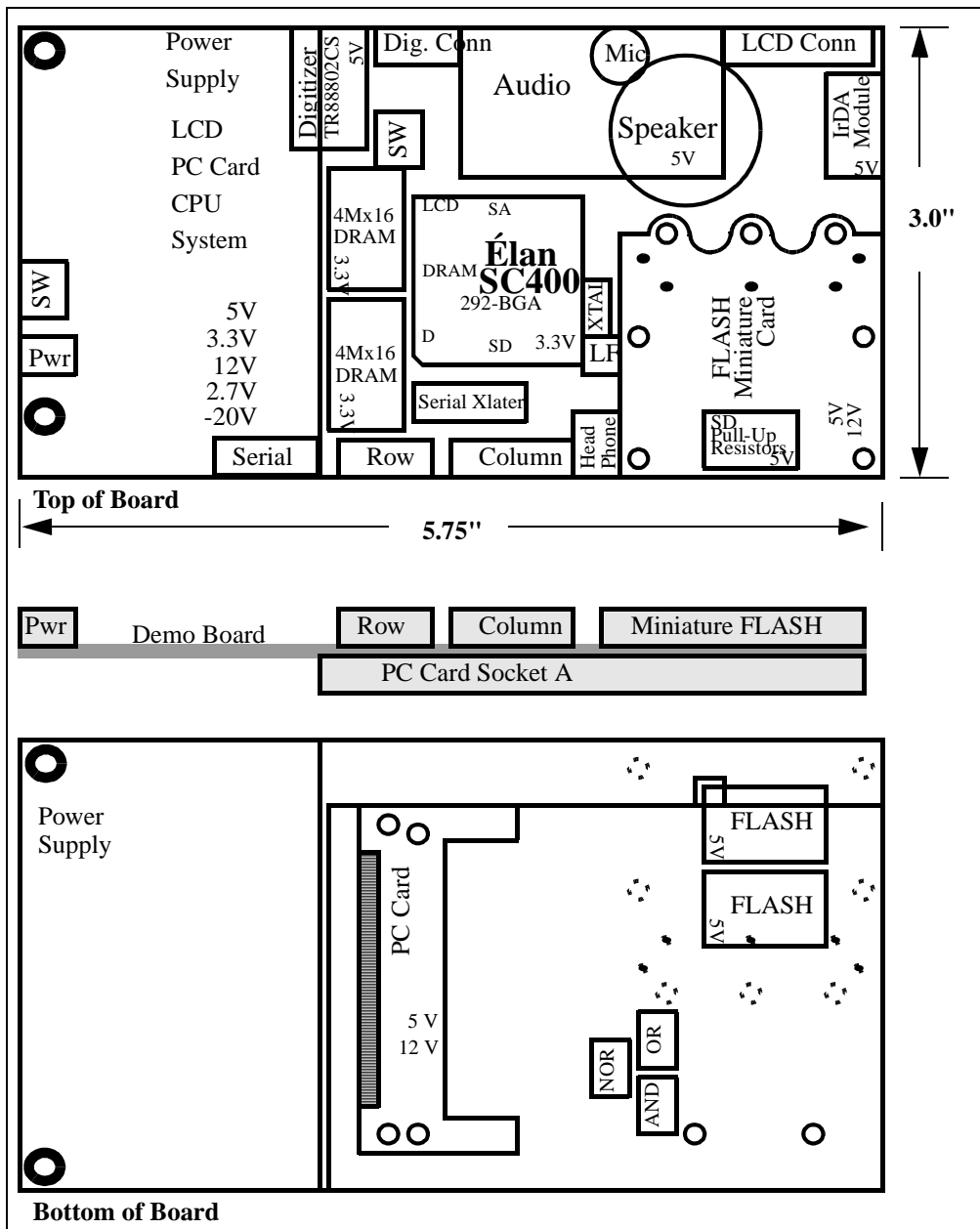


Figure 2-1.  $\mu$ forCE™ System Board Layout

---

# Élan™SC400 Microcontroller

The ÉlanSC400 microcontroller is the main chip on the µforCE system board. This highly-integrated, low-power microcontroller provides direct control of the following system features:

- DRAM, on page 2-4
- Display, on page 2-4
- Matrix keyboard, on page 2-6
- ROM/Flash memory, on page 2-7
- PC card, on page 2-7
- Serial port, on page 2-7
- IrDA infrared port, on page 2-7
- ISA bus devices
- Power supply, on page 2-8

The ÉlanSC400 microcontroller is provided in a 292-pin BGA package that is soldered directly onto the system board. See Chapter 3, “Élan™SC400 Microcontroller Signals” for more information about ÉlanSC400 microcontroller system control.

---

## DRAM

The DRAM in the  $\mu$ forCE system is designed for maximum flexibility. The base system is populated with two 4M x 16 DRAMs, one on bank 0 and one on bank 1, providing 16 Mbyte of memory. Memory options on the board are as shown in Table 2-1 on page 2-4.

**Table 2-1. DRAM Options**

<b>Bank 0</b>	<b>Bank 1</b>	<b>Total Memory</b>
1M x 16	x	2 Mbyte
1M x 16	1M x 16	4 Mbyte
4M x 16	x	8 Mbyte
1M x 16	4M x 16	10 Mbyte
4M x 16	1M x 16	10 Mbyte
4M x 16	4M x 16	16 Mbyte (default)

The DRAM chips are 3.3 V for low power. Self-refresh DRAMs are used to reduce the Suspend mode currents. The x16-data-bit DRAM interface allows matrix-keyboard and internal-graphics operation of the ÉlanSC400 microcontroller.

---

## Display

The  $\mu$ forCE system display is provided by a monochrome LCD with a resistive-touch screen overlay.

---

## LCD

The ÉlanSC400 microcontroller provides the control signals for the LCD and switches the LCD voltages correctly. Table 2-2 on page 2-5 contains the signals and signal descriptions.

**Table 2-2. LCD Signals**

Signal	Description
M	<b>LCD Panel AC Modulation</b> is the AC modulation signal for the LCD. AC modulation causes the LCD panel drivers to reverse polarity to prevent an internal DC bias from forming on the panel.
FRM	<b>LCD Panel Line Frame Start</b> is asserted by the chip at the start of every frame to indicate to the LCD panel that the next data clocked out is intended for the start of the first scan line on the panel. Some panels refer to this signal as FLM or S (scan start up).
SCK	<b>LCD Panel Shift Clock</b> is the nibble/byte strobe used by the LCD panel to latch a nibble or byte of incoming data. Commonly referred to by LCD panels as CL2 or CP2.
LC	<b>LCD Panel Line Clock</b> is activated at the start of every pixel line. Commonly referred to by LCD data sheets as CL1 or CP1.
LCDD7–LCDD3	<b>LCD Panel Data bits:</b> This is a 4-bit LCD so LCDD7–LCDD4 are not used. LCDD3–LCDD0 are the data bits for the LCD panel interface. When driving 4-bit single-scan panels, bits 3–0 form a nibble-wide LCD data interface.
DISP_ON	<b>Display On:</b> Because the ÉlanSC400 microcontroller doesn't provide a DISP_ON signal, it is generated on the board using LVEE# through a resistor and capacitor to delay the signal.

$V_{DD}$  for the LCD is 3.3 V and is switched on and off by the ÉlanSC400 microcontroller's  $\overline{LVDD}$  signal using a Linear Tec LTC1478 voltage switch.

$V_{EE}$  for the LCD is nominally +28 V. It is generated by a Micrel MIC3172 and switched on and off the ÉlanSC400 microcontroller's  $\overline{LVEE}$  signal using a FET switch circuit.

For more information about the LCD, see “Liquid Crystal Display (LCD)” on page 1-2. For more information about the ÉlanSC400 microcontroller's LCD control signals, see the ÉlanSC400 microcontroller documentation included in your kit.

---

## Touch Screen

The LCD has a resistive-touch screen overlay that interfaces to the system board through a four-signal flex cable.

The touch screen is controlled by a TriTech TR88802CS Pen Input Processor. This controller is connected to the ISA bus and is chip selected by the ÉlanSC400 microcontroller's  $\text{GPIO\_CS1}$  signal.  $\text{GPIO\_CS1}$  is programmed as an I/O chip select, and is qualified with  $\overline{\text{IOR}}$ .

The ÉlanSC400 microcontroller's  $\text{PIRQ1}$  signal is used as the digitizer interrupt to the system when new data from the controller is available. To get valid data, the digitizer controller must be read while  $\text{PIRQ1}$  is Low.  $\text{GPIO\_CS2}$  is used as an input to the ÉlanSC400 microcontroller to receive the digitizer's signal indicating the stylus is in contact with the touch panel.

---

## Matrix Keyboard

A matrix keyboard connected directly to the ÉlanSC400 microcontroller's matrix keyboard controller interface provides the system keyboard input. Fourteen row signals and seven column signals are used to scan the keyboard for a key press.

When no key is pressed, the column signals are driven Low and an interrupt is generated by a row going Low from a key press. While a key is pressed, the keyboard timer is used to interrupt the system and allow key scanning.



---

## ROM/Flash Memory

The  $\mu$ forCE demonstration system board contains 4 Mbyte of Flash memory to hold the system HAL, operating system, and applications. The Flash memory is configured with a x16-data-bit interface to optimize system performance. Two AMD 2M x 8 Flash memory chips (AM29F016s) are used in parallel, one on SD7:0, the other on SD15:8.

---

## PC Card

The  $\mu$ forCE system board supports one standard Type II PC card socket and one Flash Miniature Card socket. Because these sockets are unbuffered, the system only supports 5-V PC cards.

A jumper on the system board enables you to boot the system from the PC card, allowing easier debugging and loading of the on-board Flash memory devices.

---

## Serial Port

The  $\acute{E}$ lanSC400 microcontroller's internal UART is available for use as a serial port on the system board. The UART is shared between the serial port and the IrDA so only one is available at any time. The serial port is provided as a 10-pin header that a ribbon cable serial connector plugs into. (This ribbon cable has a 10-pin, 1/10th center, 2 x 5 connector on one end, and a 9-pin D-shell serial connector on the other end.) The serial port is buffered with a standard level-translating serial transceiver.

---

## IrDA Port

The  $\mu$ forCE system board provides for IrDA communications of up to a 1-Mbyte transfer rate.

---

## Audio

The system board contains a Crystal Semiconductor Audio chip (model# CS4236B). Both the dynamic speaker and the microphone are connected. This chip is connected to the ISA bus and uses PIRQ0 and PDRQ0.

---

## Power Supply

The power supply provides the voltages needed by the system board: 2.7 V, 3.3 V, 5 V, 12 V, and +28 V. The power supply draws its power from either an AC wall plug that provides +12 V, or a four-AA-cell NiMH battery pack.

## Chapter 3



---

# Élan™SC400 Microcontroller Signals

This chapter provides system-specific considerations for the ÉlanSC400 microcontroller signals and brief descriptions of those signals.

# Signal Considerations

Table 3-1 summarizes the special signal considerations in this system.

**Table 3-1. Élan™SC400 Microcontroller Signal Considerations**

ÉlanSC400 Pin Name	System Board Signal Name	Low	High	Notes
GPIO_CS0	SUSPDIS#	Suspend mode	Reset and operation	Low to disable devices in Suspend mode: - Serial Port transceiver, disabled when Low - VCCSUSP - off when Low Provides VCC to: - SD pull-up resistors - Audio analog circuits (Mic, speaker, headphone)
Not a controller signal  Invert on the system board	SUSPDIS	Reset and operation	Suspend mode	Inverted SUSPDIS# also available on system board. High to disable devices in Suspend mode: - IrDA LED's - Low-Power mode when High - Digitizer - Reset when High - Low power when High - VCC3 and VCC5 power supplies - Skip mode is the Low-Power mode of the power supplies
GPIO_CS1	DIG_CS#	Chip selected	Chip not selected	I/O chip select for digitizer Address qualified with IOR
GPIO_CS2	PEN_OFF	Pen detected	Pen not detected	Input to indicate the pen is on the digitizer
GPIO_CS4	FSTCHRG#	Suspend mode	Reset, operation, and suspend	Low to enable fast charge of the batteries. High to enable slow charge of the batteries. Should slow charge the batteries when the system is operating (any PMU mode other than Suspend). Should fast charge the batteries if in Suspend mode. Has no affect when the AC wall plug is not connected.

ÉlanSC400 Pin Name	System Board Signal Name	Low	High	Notes															
GPIO_CS5	CHARGE#	Reset and enable charger	Disable charger circuit	Enable for battery charge circuit. Battery charge firmware uses this signal to enable/disable the charge on the battery for optimal charging.															
PIRQ0	PIRQ0			Audio chip interrupt request															
PIRQ1	PIRQ1			Digitizer chip new data request															
PDRQ0 PDACK0 AEN	PDRQ0 PDACK# AEN			Audio chip DMA															
$\overline{\text{PCMA\_VCC}}$	PCMVCCA#	Reset, operation, and suspend	Operation and suspend	- Low to enable 5 V to PC card socket A - High to disable 5 V to PC card socket A															
PCMA_VPP1 PCMA_VPP2	PCMVPP1A and PCMVPP2A	Operation and suspend	Reset, operation, and suspend	Control signals for PC card socket A VPP: <table style="margin-left: 20px;"> <tr> <td>PCMVPP1A</td> <td>PCMVPP2A</td> <td>Socket VPP</td> </tr> <tr> <td>0</td> <td>0</td> <td>0V</td> </tr> <tr> <td>0</td> <td>1</td> <td>5V</td> </tr> <tr> <td>1</td> <td>0</td> <td>12V</td> </tr> <tr> <td>1</td> <td>1</td> <td>Off</td> </tr> </table> PCMVPP1A is also used to enable the 12-V power supply. - High - 12 V enabled - Low - 12 V disabled (and supply in Low-Power mode).	PCMVPP1A	PCMVPP2A	Socket VPP	0	0	0V	0	1	5V	1	0	12V	1	1	Off
PCMVPP1A	PCMVPP2A	Socket VPP																	
0	0	0V																	
0	1	5V																	
1	0	12V																	
1	1	Off																	
PCMB_VCC	PCMVCCB#	Reset, operation, and suspend	Operation and suspend	Low to enable 5 V to PC card socket B High to disable 5 V to PC card socket B															
$\overline{\text{LVDD}}$	LVDD#	LCD enabled	Reset and LCD disabled	Switch 3.3 V on/off to LCD - High - LCD VCC disabled - Low - LCD VCC enabled															
$\overline{\text{LVEE}}$	LVEE#	LCD enabled	Reset and LCD disabled	Switch LCD Contrast Voltage (22 V –28 V) on/off to LCD - High - LCD VEE disabled - Low - LCD VEE enabled $\overline{\text{LVEE}}$ is also inverted on the board to turn the LCD VEE power chip on/off															

ÉlanSC400 Pin Name	System Board Signal Name	Low	High	Notes
$\overline{\text{LBL2}}$	LBL2#	Critical Suspend mode	Reset and all other times	Used to hold the audio chip in reset during Critical Suspend mode. Reset is the hardware method of putting the audio chip in Low-Power mode. During Normal Suspend mode, the audio chip will be programmed into Low-Power mode; there is no time for an interrupt when $\overline{\text{BL2}}$ falls and forces Critical Suspend mode.
ACIN	ACIN	Battery power only	AC power available	Input to the ÉlanSC400 to indicate the wall plug is in use and PMU should be disabled.
$\overline{\text{BL0}}\text{--}\overline{\text{BL2}}$	BL0–BL2#	Battery power is low	Battery power is OK	<p><math>\overline{\text{BL0}}</math> is the first level of battery power report.</p> <ul style="list-style-type: none"> <li>- Set to 5.0 V and causes battery-life report to show low</li> </ul> <p><math>\overline{\text{BL1}}</math> is the second level of battery power report</p> <ul style="list-style-type: none"> <li>- Set to 4.8 V and causes battery-life report to show very low</li> </ul> <p><math>\overline{\text{BL2}}</math> is the last level of battery power report</p> <ul style="list-style-type: none"> <li>- Forces the microcontroller into Critical Suspend mode</li> <li>- Set to 4.7 V</li> </ul>

---

## Signal Descriptions

In this section, the first name in each heading is the microcontroller pin name and the second name is the signal name on the  $\mu$ forCE system board. Where only one name is listed, the signals have the same names.

---

### GPIO\_CS0/SUSPDIS#

The GPIO\_CS0 signal is used to disable several devices external to the ÉlanSC400 microcontroller to save power when the microcontroller is in Suspend mode. GPIO\_CS0 will be driven Low in Suspend mode, and will be driven High in all other PMU modes. To make this behavior automatic, GPIO\_CS0 is programmed internally to GPIO\_PMUA. When driving a GPIO\_CS pin with an internal GPIO\_PMU signal, the pin must be configured as an output. The GPIO\_PMU signal is configured to be Low in Suspend mode, and High for all other PMU modes.

**Table 3-2. GPIO\_CS0 Register**

Index[Bits]	Description	Setting
A0h[3–0]	Map GPIO_PMUA to GPIO_CS0	0000
A0h[0]	Enable GPIO_CS0 as an output	1
AAh[5–0]	GPIO_PMUA Mode Change Register	11 1110
A6h[0]	GPIO_CS0 output clear	0

---

### GPIO\_CS1/DIG\_CS#

The GPIO\_CS1 signal is used as a chip select for the TriTech touch-overlay controller. GPIO\_CS1 pulses Low when I/O reads occur from one of the four addresses required by the TriTech status registers. To support this operation, GPIO\_CS1 is programmed internally to GPCSA. When using a GPIO\_CS pin as a chip select, the pin must be configured as an output.

Software is responsible for selecting an otherwise unused address range at which to map the TriTech registers (300h–303h is used). The base address is configured via indices B4h[7–0] and B5h[1–0]. The number of addresses decoded from the base is configured via index B5h[5–2]. In our case, only bits 2 and 3 of this bit field will be cleared to allow chip-select generation for offsets 0–3 from the base address. In addition, the chip select should only be asserted on  $\overline{I/O}$  reads because these are read-only registers; we qualify the addresses with  $\overline{I/O}$ , using index B8h[1–0].

The TriTech X,Y coordinate registers will be accessed as follows:

- 300h: Y coordinate bits 1–0
- 301h: Y coordinate bits 9–2
- 302h: X coordinate bits 1–0
- 303h: X coordinate bits 9–2

This arrangement allows software to do an **IN AX,DX** instruction followed by a **SHR AX,6** to make the digitizer value 0 based. Table 3-3 shows the GPIO\_CS1 register considerations.

**Table 3-3. GPIO\_CS1 Register**

Index[Bits]	Description	Setting
B2h[3–0]	Map GPCSA to GPIO_CS1	0001
A0h[2]	Enable GPIO_CS1 as an output	1
A6h[1]	GPIO_CS1 output clear	0
B4h[7–0]	GPCSA SA[7–0] decode	0000 0000
B5h[1–0]	GPCSA SA[9–8] decode	11
B5h[5–2]	GPCSA SA[3–0] Mask Register	1100
B8h[2]	GPCSA bus width = 8 bit	0
B8h[1–0]	GPCSA qualified with $\overline{I/O}$	01



---

## GPIO\_CS2/PEN\_OFF

The GPIO\_CS2 signal is used to read back the state of pen up/down from the TriTech controller. Reading back a 0 from this register indicates the pen is in contact with the touch screen, and reading back a 1 indicates pen up. GPIO\_CS2 is configured internally to be a GPIO input to support this function; the state of the GPIO can be read from index A6h[2]. The pen-down indication will be used as an activity; this requires that GPIO\_CS2 be configured as an activity via index A0h[5]. The activity status bit for GPIO\_CS2 is at index 5Ah[2]. You do not need any internal pin termination because the TriTech chip does not use an open-collector output to drive this input.

Because the TriTech controller does not send the pen status when it is in Low-Power mode (during Suspend mode) you cannot use this as a wake-up for the system. Table 3-4 shows the GPIO\_CS2 register considerations.

**Table 3-4. GPIO\_CS2 Register**

Index[Bits]	Description	Setting
A0h[4]	Enable GPIO_CS2 as an input	0
A0h[5]	Enable GPIO_CS2 as an activity	1
A6h[2]	Read the state of GPIO_CS2	read
5Ah[2]	GPIO_CS2 activity status bit	read
3Bh[2]	Disable GPIO_CS2 pull-up resistor	0

---

## GPIO\_CS4/FSTCHRG#

The GPIO\_CS4 signal selects whether the charger is running in Fast Charge (GPIO\_CS4 is Low) or Slow Charge (GPIO\_CS4 is High) mode. The power supply does not have enough capacity to fast charge the batteries while the system is in any mode other than Standby or Suspend. Thus, when the system is in Standby or Suspend mode, and is running from wall power, you will fast charge the batteries. During most other instances while the wall power is applied, the batteries will be slow charging.

To make the selection between Fast Charge and Slow Charge mode automatic for most conditions, GPIO\_CS4 is programmed internally to GPIO\_PMUB. When driving a GPIO\_CS pin with an internal GPIO\_PMU signal, the pin must be configured as an output.

Note that when mapping GPIO\_PMUA and GPIO\_PMUB to external GPIO\_CS pins for the purpose of controlling the GPIO\_CS pins based on the PMU mode, you must also configure the desired GPIO\_CS pins to be outputs (see CSC indexes A0–A3h). You must also ensure that the bits in index register A6h or A7h, which correspond to the GPIO\_CS pins you are controlling based on PMU mode, have been cleared.

Configure the GPIO\_PMU signal to be Low in Suspend and Standby modes, and High for all other PMU modes. Also note that the use of a GPIO\_PMU signal to drive the GPIO\_CS pin with does not mean that manual control of a fast or slow charge is not possible. Under certain charging conditions, it may be better to slow charge even when in Suspend mode. This control has no effect if the wall adapter is not plugged in. Table 3-5 shows the GPIO\_CS4 register considerations.

**Table 3-5. GPIO\_CS4 Register**

<b>Index[Bits]</b>	<b>Descriptions</b>	<b>Setting</b>
A6h[7–4]	Map GPIO_PMUB to GPIO_CS4	0100
A1h[0]	Enable PIO_CS4 as an output	1
ABh[5–0]	GPIO_PMUB Mode Change Register	11 1100
A6h[4]	GPIO_CS4 output clear	0

---

## GPIO\_CS5/CHARGE#

The GPIO\_CS5 signal controls the enable for the charging circuit. When GPIO\_CS5 is High, the charger is disabled. When Low, charging occurs at the rate (fast/slow) defined by the state of GPIO\_CS4. To support this feature, GPIO\_CS5 is configured internally to be a GPIO output. You can control the state of the GPIO from index A6h[5]. Table 3-6 shows the GPIO\_CS5 register considerations.

**Table 3-6. GPIO\_CS5 Register**

Index[Bits]	Descriptions	Setting
A1h[2]	Enable PIO_CS5 as an output	1
A6h[5]	Set GPIO_CS5 High or Low	1 or 0

---

## PIRQ0

The PIRQ0 signal is connected to the Crystal Semiconductor audio chip's IRQ output. PIRQ0 is mapped to IRQ11 inside the ÉlanSC400 microcontroller by programming D4h[3–0] to 1101.

---

## PIRQ1

The PIRQ1 signal is connected to the TriTech touch-overlay controller's "new data" output. The touch-overlay controller asserts this output when a new coordinate sample (X,Y) is available to be read by the system. A higher-priority interrupt is used to minimize the opportunity for loss of pen data during inking operations. The data comes in from the TriTech chip at 200 samples/s. PIRQ1 is mapped to IRQ9 inside the ÉlanSC400 microcontroller by programming D4h[7–4] to 1001. Only IRQ0, IRQ1, and IRQ8 are higher priority.

---

## **PDRQ0 and $\overline{\text{PDACK0}}$ /PDACK#**

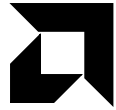
PDRQ0/ $\overline{\text{PDACK0}}$  is routed to the Crystal Semiconductor audio chip. The audio chip is only capable of 8-bit DMA, and is restricted to using channels 0–3. The IrDA port uses DMA0. An external PCMCIA floppy card will require that DMA channel 2 be open. The use of DMA channel 1 may be required for an internal IrDA workaround being considered now, so DMA channel 3 is used for the audio chip. This is routed via index DBh[2–0].

---

## **LBL2/LBL2#**

If the system goes into Critical Suspend mode, the  $\overline{\text{LBL2}}$  signal holds the audio chip in reset, which is the minimum power-consumption mode. If  $\overline{\text{LBL2}}$  is ever asserted, the audio chip must be completely re-initialized by power-management software.

# Chapter 4



---

## Power Management

The ÉlanSC400 microcontroller contains a flexible Power Management Unit (PMU) to control the chip and system power. The PMU has seven modes of operation for the system to use; six of these modes are implemented to reduce the system power. The maximum clock speed used is 33 MHz in High-Power mode. Because the system performance is so good, AMD did not implement the 66-MHz Hyper-Speed mode. Figure 4-1 on page 4-2 shows the PMU modes.

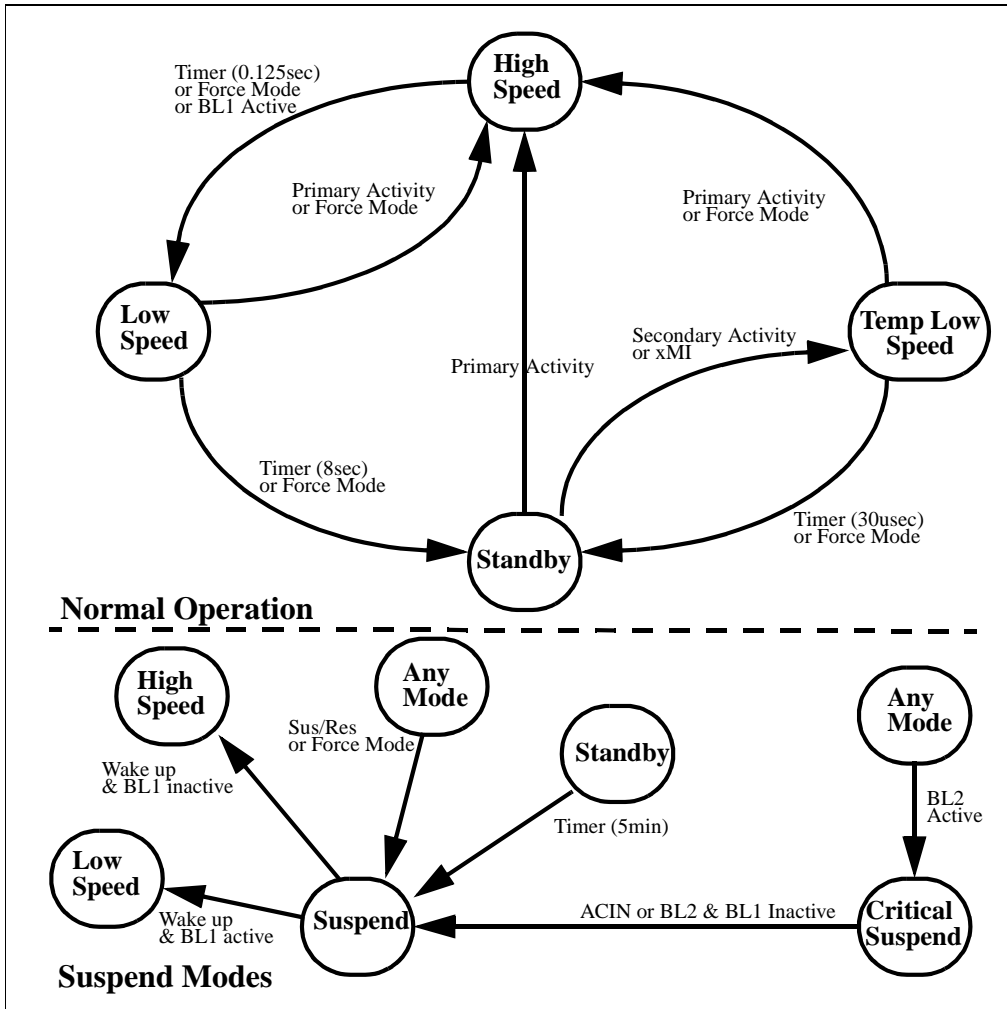


Figure 4-1. Power Management Modes

# PMU Modes

Table 4-1 provides a brief description of the seven PMU modes.

**Table 4-1. PMU Mode Description**

PMU Mode	CPU Speed (MHz)	Timer Value	Enter Mode	Exit Mode
Hyper Speed	66	0.125 seconds	Not used	Not used
High Speed	33	0.125 seconds	- Primary activity - Force mode - Wake-up and $\overline{BL1}$ inactive	- Timer - Force Mode - $\overline{BL1}$ or $\overline{BL2}$ active
Low Speed	1	8 seconds	- HS timer - Force mode - $\overline{BL1}$ active	- Timer - Force Mode - Primary activity - $\overline{BL2}$ active
Temporary Low Speed	1	30 $\mu$ seconds	- Interrupt in Standby mode - Secondary activity	- Timer - Force Mode - Primary activity - $\overline{BL2}$ active
Standby	0	1 minute	- LS timer - Force mode	- Timer - Activity - $\overline{BL2}$ active
Suspend	N/A	Disabled	- SUS/RES switch - CS unlock	- Wake-up - $\overline{BL2}$ active
Critical Suspend	N/A	N/A	- $\overline{BL2}$ active	- ACIN active - $\overline{BL2}$ and $\overline{BL1}$ inactive

---

# High-Speed Mode

High-Speed mode is programmed to 33 MHz and is used to service CPU intensive functions in the system (i.e., Excel calculations, searches, application launch, etc.).

Hardware control of entering this mode is accomplished using the primary activities. Any system events that cannot be recognized by software are programmed to cause a primary activity. The Battery-Low signals ( $\overline{BLx}$ ) also have an affect on High-Speed mode.  $\overline{BL0}$  limits the CPU speed to 8 MHz, and  $\overline{BL1}$  disables High-Speed mode and makes Low-Speed mode the highest available mode.

Software control of High-Speed mode is accomplished using the PMU Force Mode Register (CSC Index 40h). When a system event occurs that requires High-Speed mode performance, the operating system uses the PMU Force Mode Register to change the PMU to High-Speed mode. When the time-critical code is complete, the software uses the PMU Force Mode Register again to put the PMU back into Standby mode.

System events that require High-Speed mode include the following:

- CPU access to DRAM memory
- Application launch and closing
- Any search functions (e.g., find name/address)
- Read/write a file in Flash memory



---

## Low-Speed Mode

Low-Speed mode is programmed to 1 MHz and is used to service functions in the system that are not time critical (e.g., read pen input, accept a key press, etc.).

Hardware control of entering this mode is accomplished using  $\overline{\text{BLI}}$ . When  $\overline{\text{BLI}}$  is detected as active, the system disables High-Speed mode, and Low-Speed mode becomes the highest PMU mode.

All system events that do not need High-Speed mode performance are programmed to cause a secondary activity. When secondary activities are received while in Low-Speed mode, the low-speed timer is reset and starts the countdown over. Any primary activities that are received while in Low-Speed mode cause the system to return to High-Speed mode.

Software control of Low-Speed mode is accomplished using the Force Mode Register. When a system event occurs that does not require High-Speed mode performance, the operating system uses the Force Mode Register to change the PMU to Low-Speed mode. When the code is done, the software uses the Force Mode Register again to put the PMU back into Standby mode.

System events that require Low-Speed mode include the following:

- Keyboard input
- Pen input

---

## Temporary Low-Speed Mode

Temporary Low-Speed mode operates at the same clock speed as Low-Speed mode (1 MHz). This mode is used to service secondary activities and interrupts when they are received while the system is in Standby mode.

Hardware control of entering this mode is accomplished using the secondary activities, SMI, or NMI. Temporary Low-Speed mode is only entered from Standby mode. Temporary Low-Speed mode has a much shorter timer than Low-Speed mode and allows the system to get back to Standby mode faster. While in Temporary Low-Speed mode, any primary activities that are received put the PMU into High-Speed mode. The Temporary Low-Speed timer is programmed to its shortest value (30  $\mu$ s) to put the PMU back into Standby mode as soon as possible. Any secondary activities that are received while in Temporary Low-Speed mode reset the timer.

Software control of Temporary Low-Speed mode is accomplished using the Force Mode Register. The only way to enter Temporary Low-Speed mode is through the use of the hardware secondary activity, SMI, or NMI because the system is coming from a clock-off mode (Standby mode). Once in Temporary Low-Speed mode, the software can use the Force Mode Register to change to any other mode based on the operations to be run.

System events that require Temporary Low-Speed mode include the following:

- Keyboard input
- Pen input

---

## Standby Mode

Standby mode is used when the system is inactive while waiting for an event. This mode has the CPU clock stopped, the high-speed PLL disabled, and the LCD enabled. Most of the time when the system is on and displaying, it is in Standby mode waiting for an activity (key press, pen input, etc.).

Hardware control of entering this mode is accomplished using the Low-Speed and Temporary Low-Speed timers. This mode is exited to High-Speed mode when a primary activity is detected, to Temporary Low-Speed mode when a secondary activity, SMI, or NMI is detected, or to Suspend mode when the standby timer expires (5 minutes).

Software has no control in Standby mode because the CPU clock is stopped. Software will program the system into Standby mode when there is no immediate need to remain in a higher-power mode.

System events that require Standby mode include the following:

- Waiting for activity

---

## Suspend Mode

Suspend mode is used when the system is off; it is the lowest power mode in the system. DRAM is self-refreshed and the PLLs are disabled. The system is waiting for a wake-up to resume operation.

Hardware control of entering Suspend mode is accomplished using the Standby timer and the PROG key on the keyboard. This mode is also entered when an unlock is accomplished in Critical Suspend mode. Suspend mode is exited when a wake-up is detected, and the system returns to High-Speed mode (normal wake-up) or to Low-Speed mode if BLI is detected active.

Software has no control in Suspend mode because the CPU clock is stopped. Before entering Suspend mode, software must program the audio chip into its Low-Power mode.

---

## Critical Suspend Mode

Critical Suspend mode is basically the same as Suspend mode, but the system can only enter Critical Suspend from a  $\overline{BL2}$  assertion. The system also cannot wake up from Critical Suspend mode; it must first be unlocked by either an ACIN assertion, or the deassertion of both  $\overline{BL2}$  and  $\overline{BL1}$ .

$\overline{BL2}$  can be asserted at any time, with the PMU in any mode. The system will immediately drop to Critical Suspend mode by hardware control. This causes the audio chip to be held in reset (the hardware method of enabling Low-Power mode), so it will have to be reprogrammed when the system wakes up.



---

# Index

---

---

## A

---

AC/DC wall adapter, 1-3  
ACIN signal, 3-4  
AEN signal, 3-3  
ALPs Electric, Inc., iv  
Am186CC/CH/CU CDP  
    documentation conventions, xiii  
audio, 2-8

---

## B

---

battery pack, 1-3  
BGA package, 1-1  
BL0–BL2 pin, 3-4  
BL0–BL2# signals, 3-4  
bsquare Tools, iv

---

## C

---

CDP  
    documentation conventions, xiii  
CHARGE# signal, 3-9  
Critical Suspend mode, 4-8  
Crystal Semiconductor Corporation, iv

---

## D

---

DIG\_CS# signal, 3-5  
DISP\_ON signal, 2-5  
display. *See* LCD.  
documentation  
    conventions, xiii  
    overview, xii  
    support, iii  
DRAM  
    memory options, 2-4  
    overview, 2-4

---

## E

---

ÉlanSC400 microcontroller  
    overview, 2-3  
    signal considerations, 3-2  
    signal descriptions, 3-5  
    signal overview, 3-1

---

## F

---

Flash memory. *See* ROM/Flash memory.  
FRM LCD signal, 2-5  
FSTCHRG# signal, 3-7  
FusionE86 support, iii

---

## G

---

GPIO\_CS0 pin, 3-5  
GPIO\_CS0 register, 3-5  
GPIO\_CS1 pin, 3-5  
GPIO\_CS1 register, 3-6  
GPIO\_CS2 pin, 3-7  
GPIO\_CS2 register, 3-7  
GPIO\_CS4 pin, 3-7  
GPIO\_CS4 register, 3-8  
GPIO\_CS5 pin, 3-9  
GPIO\_CS5 register, 3-9

---

## H

---

High-Speed mode, 4-4  
Hyper-Speed mode, 4-3

---

## I

---

infrared. *See* IrDA port.  
IrDA port, 2-7

---

## K

---

keyboard  
matrix, 1-3, 2-6

---

## L

---

$\overline{\text{LBL2}}$  pin, 3-4, 3-10  
LBL2# signal, 3-4, 3-10  
LC LCD signal, 2-5  
LCD

overview, 1-2, 2-5  
signals, 2-5  
specifications, 1-2  
touch screen, 2-6  
VDD, 2-6  
VEE, 2-6  
LCDD7–LCDD3 LCD signals, 2-5  
Liquid Crystal Display (LCD). *See* LCD.  
Low-Speed mode, 4-5  
LVDD pin, 3-3  
LVDD# signal, 3-3  
LVEE pin, 3-3  
LVEE# signal, 3-3

---

## M

---

M LCD signal, 2-5  
manual  
about, xii  
memory. *See* ROM/Flash memory.  
 $\mu$ forCE demonstration system  
about, ix  
block diagram, x  
board features, 1-4  
board functional description, 2-1  
components, 1-2  
features, xi, 1-1  
overview, 1-1  
system board layout, 2-2  
Micrel Semiconductor, iv  
Microsoft, iv

---

## N

---

NiMH batteries, 1-3  
Notational conventions, xiii

---

## P

---

PC card, 2-7  
PCMA\_VCC pin, 3-3  
PCMA\_VPP pins, 3-3  
PCMB\_VCC pin, 3-3  
PCMVCAA# signal, 3-3  
PCMVCCB# signal, 3-3  
PCMVPP1A signal, 3-3  
PCMVPP2A signal, 3-3  
PDAck# signal, 3-10  
PDAck0 pin, 3-10  
PDRQ0, 2-8  
PDRQ0 pin, 3-10  
PEN\_OFF signal, 3-7  
PIRQ0, 2-8  
PIRQ0 pin, 3-9  
PIRQ1 pin, 3-9  
PMU. *See* power management.  
power management  
    Critical Suspend mode, 4-8  
    High-Speed mode, 4-4  
    Low-Speed mode, 4-5  
    modes diagram, 4-2  
    modes overview, 4-3  
    overview, 4-1  
    Standby mode, 4-7  
    Suspend mode, 4-7  
    Temporary Low-Speed mode, 4-6  
power supply, 2-8  
    AC/DC wall adapter, 1-3  
    battery pack, 1-3  
    overview, 1-3

---

## R

---

reference material, xiii  
ROM/Flash memory, 2-7

---

## S

---

SCK LCD signal, 2-5  
screen. *See* LCD.  
serial port, 2-7  
signals. *See* ÉlanSC400 microcontroller signals.  
Standby mode, 4-7  
STN technology, 1-2  
support  
    documentation, iii  
    FusionE86, iii  
    technical, iii  
    tools, iv  
    WWW, iii  
SUSPDIS signal, 3-2  
SUSPDIS# signal, 3-5  
Suspend mode, 4-7

---

## T

---

Temporary Low-Speed mode, 4-6

---

## V

---

voltage. *See* power supply.

---

## W

---

WWW support, iii

